TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

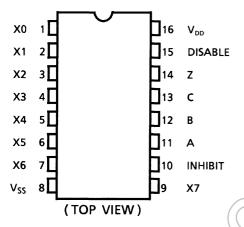
# TC4512BP, TC4512BF

#### TC4512B 8-Channel Data Selector

TC4512B is data selector which selects 8 channel data inputs (X0 through X7) according to binary address inputs A, B and C. Since high impedance can be given to output Z by setting DISABLE input to "H", the wired-OR arrangement can be achieved. DISABLE input takes precedence over other inputs giving the output high impedance.

If DISABLE = "L" and INHIBIT = "H", the data select operation is inhibited and output Z becomes "L" Level.

#### **Pin Assignment**

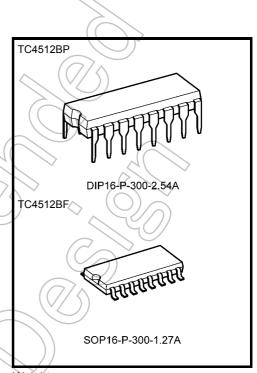


#### **Truth Table**

				\ V /			
	Inputs						
Α	В	C	Inhibit	Disable	Z		
L	L	L	1/	L	X0		
Н	L	L	L	_ L	X1		
L	Н	-	7	L	X2		
Н	Н	+(		L	X3		
L (	_ L (	( H )	L	٦ (	X4		
Н	1	$\neq$	L 🔿	( <u>L</u>	X5		
1	H	(±	L	$\wedge$	X6		
Н	7	Н	Lζ	7	X7		
*	*	*	Н		L		
*	*	*	*	Н	HZ		

\*: Don't care

HZ: High impedance

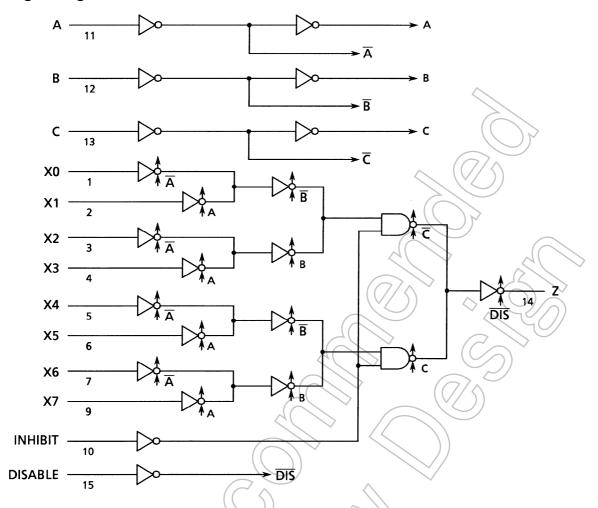


Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

Start of commercial production 1978-04

#### **Logic Diagram**



# **Absolute Maximum Ratings (Note)**

	_/ / /		
Characteristics	Symbol	Rating	Unit
DC supply voltage	V <sub>DD</sub>	V <sub>SS</sub> = 0.5 to V <sub>SS</sub> + 20	V
Input voltage	VIN	V <sub>SS</sub> = 0.5 to V <sub>DD</sub> + 0.5	V
Output voltage	V <sub>OUT</sub>	V <sub>SS</sub> – 0.5 to V <sub>DD</sub> + 0.5	V
DC input current	IIN	±10	mA
Power dissipation	PD	300 (DIP)/180 (SOIC)	mW
Operating temperature range	T <sub>opr</sub>	-40 to 85	°C
Storage temperature range	T <sub>stg</sub>	-65 to 150	°C

Note:

Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Operating Ranges (V<sub>SS</sub> = 0 V) (Note)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
DC supply voltage	$V_{DD}$	_	3	_	18	V
Input voltage	V <sub>IN</sub>	_	0		$V_{DD}$	V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{DD}$  or  $V_{SS}$ .

# Static Electrical Characteristics ( $V_{SS} = 0 V$ )

Characteristics		Sym-	Test Condition		-40°C		25°C			85°C		l lmit
Charac	teristics	bol		V <sub>DD</sub> (V)	Min	Max	Min	Тур.	Max	Min	Max	Unit
High-level output			1 .4 4	5	4.95	_	4.95	5.00	_	4.95	_	
		$V_{OH}$	I <sub>OUT</sub>   < 1 μA	10	9.95	_	9.95	10.00 <	_	9.95	_	V
voltago			$V_{IN} = V_{SS}, V_{DD}$	15	14.95	_	14.95	15.00		14.95	_	
			11	5	_	0.05	_	0.00	0.05	) P	0.05	V
Low-level voltage	output	$V_{OL}$	I <sub>OUT</sub>   < 1 μA	10	_	0.05	_	0.00	0.05	/_	0.05	
			$V_{IN} = V_{SS}, V_{DD}$	15	_	0.05	<b>₹</b>	0.00/	0.05	_	0.05	
			V <sub>OH</sub> = 4.6 V	5	-0.61	_	-0.51	-1.0		-0.42	_	
			V <sub>OH</sub> = 2.5 V	5	-2.5	_	-2.1	-4.0	> —	-1.7	_	
Output hig	h current	loh	V <sub>OH</sub> = 9.5 V	10	-1.5	_	-1.3	-2.2	_	-1.1	_	mA
			V <sub>OH</sub> = 13.5 V	15	-4.0	- <	3.4	9.0	_	-2.8	7	
			$V_{IN} = V_{SS}, V_{DD}$						1	2	, i	
			V <sub>OL</sub> = 0.4 V	5	0.61	(4//	0.51	1.2	-((	0.42	_	mA
Output lov	v current	I <sub>OL</sub>	V <sub>OL</sub> = 0.5 V	10	1.5		1.3	3.2	(7)	(1,1)	/ —	
Output lov	Output low current		V <sub>OL</sub> = 1.5 V	15	4.0		3.4	12.0		2.8	_	
			$V_{IN} = V_{SS},  V_{DD}$		4				$\langle \rangle$			
			V <sub>OUT</sub> = 0.5 V, 4.5 V	5	3.5	>-	3.5	2.75		3.5	_	٧
Input high	voltage	V <sub>IH</sub>	V <sub>OUT</sub> = 1.0 V, 9.0 V	10	7.0	_	7.0	5.5	) —	7.0	_	
input nign	voltage		V <sub>OUT</sub> = 1.5 V, 13.5 V	15	11,0	-//	11.0	8.25	_	11.0	_	
			I <sub>OUT</sub>   < 1 μA				Ì					
		V <sub>IL</sub>	V <sub>OUT</sub> = 0.5 V, 4.5 V	5	_	1.5		2.25	1.5		1.5	V
Input low v	voltage		V <sub>OUT</sub> = 1.0 V, 9.0 V	_10	_	3.0		4.5	3.0	_	3.0	
input low	voitage		V <sub>OUT</sub> = 1.5 V, 13.5 V	15	_	4.0	_	6.75	4.0	_	4.0	
			I <sub>OUT</sub> < 1 µA			167						
Input	"H" level	liH	V <sub>IH</sub> = 18 V	18		0.1	_	10 <sup>-5</sup>	0.1	_	1.0	μА
current <sub>"L</sub>	"L" level	/IL/	V <sub>IL</sub> = 0 V	18	(7/4)	0.1	_	$-10^{-5}$	-0.1	_	-1.0	μιτ
3-state output	"H" level	IDH	V <sub>OH</sub> = 18 V	18		0.4	_	10 <sup>-4</sup>	0.4	_	12	μА
leakage current	"L" level	I <sub>DL</sub>	V <sub>OL</sub> ≠ 0 V	18	1	-0.4	_	-10 <sup>-4</sup>	-0.4	_	-12	μΑ
Quiescent supply current		2 .	$V_{IN} = V_{SS}, V_{DD}$ (Note)	5	>	5	_	0.005	5	_	150	
		IDD		10	_	10	_	0.010	10	_	300	μΑ
			4.13.6)	15	_	20	_	0.015	20		600	

Note: All valid input combinations.

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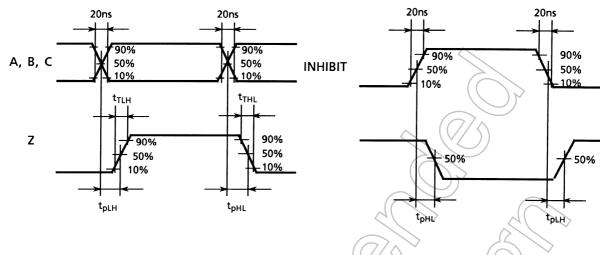
# Dynamic Electrical Characteristics (Ta = 25°C, $V_{SS}$ = 0 V, $C_L$ = 50 pF)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Characteristics	Symbol		V <sub>DD</sub> (V)	IVIIII	τyp.	IVIAX	Offic
Output transition time			5	_	80	200	
(low to high)	t <sub>TLH</sub>	_	10	_	50	100	ns
(low to riigir)			15		40	80	
Output transition time			5	(	80	200	
(high to low)	t <sub>THL</sub>	_	10		50	100	ns
(nigh to low)		,	15	<b>/</b> A	40	80	
Propagation delay time	t		5	<i>H</i>	140	280	
(INHIBIT-Z)	t <sub>pLH</sub>	_	10	· —	60	140	ns
(INTIIDIT-2)	t <sub>pHL</sub>		15	_	40	100	
Propagation delay time	t	$\mathcal{A}($	5		240	400	
(A, B, C-Z)	t <sub>pLH</sub>	-	10	- /	95	170	ns
(A, B, C-2)	t <sub>pHL</sub>	(7/4)	15	-6	65	2 120	
Propagation delay time	+		5	7-1	210	360	
, ,	t <sub>pLH</sub>	4	10	_//	85	150	ns
(X-Z)	t <sub>pHL</sub>		15 ((		60	110	
Three state disable time	<b>.</b>		5		60	120	
	t <sub>pZL</sub> , t <sub>pLZ</sub>	$R_L = 1 k\Omega$	(10//	\ _	25	60	ns
(DISABLE-Z)	t <sub>pHZ</sub> , t <sub>pZH</sub>		15	V —	20	40	
Input capacitance	C <sub>IN</sub>				5	7.5	pF

# **Waveforms for Measurement of Dynamic Characteristics**

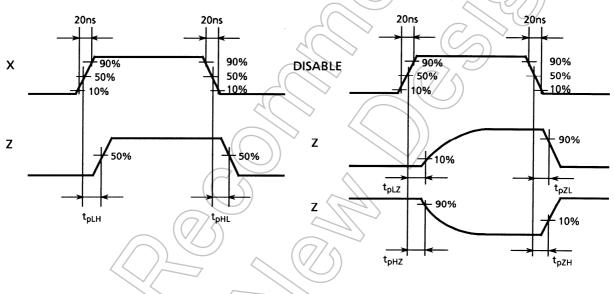
### Waveform 1

### Waveform 2 (X = "H")



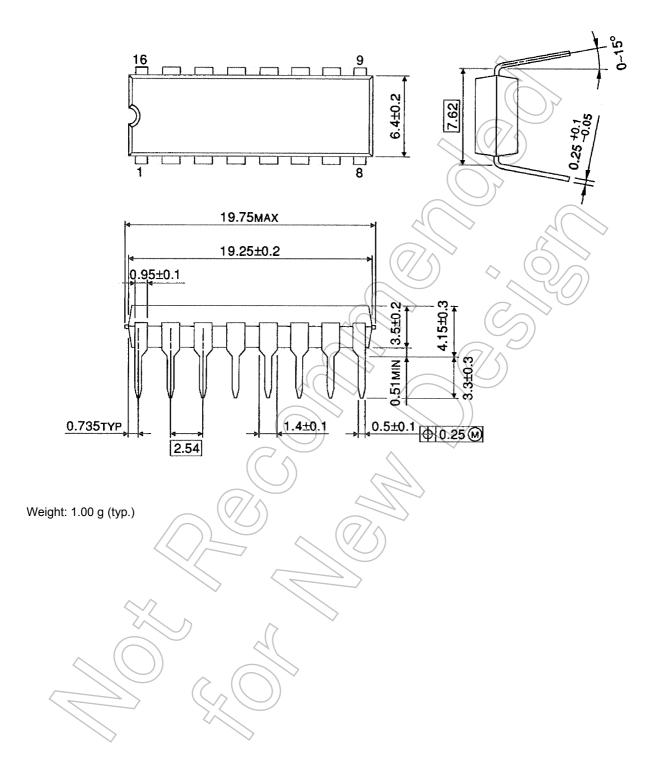
### Waveform 3

#### Waveform 4



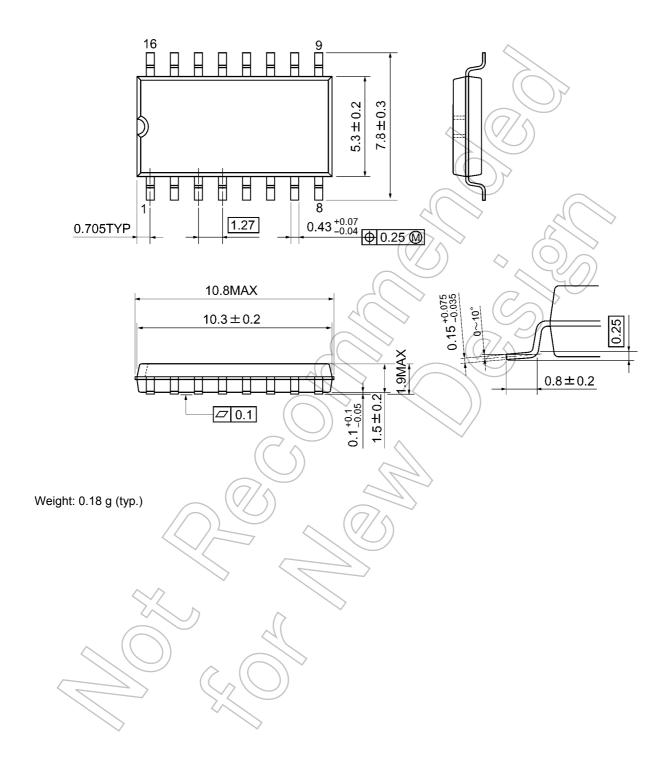
# **Package Dimensions**

DIP16-P-300-2.54A Unit: mm



# **Package Dimensions**

SOP16-P-300-1.27A Unit: mm



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